ON Semiconductor

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BF422

High Voltage Transistors

NPN Silicon

Features

• This is a Pb-Free Device*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector - Emitter Voltage	V _{CEO}	250	Vdc	
Collector - Base Voltage	V _{CBO}	250	Vdc	
Emitter - Base Voltage	V _{EBO}	5.0	Vdc	
Collector Current - Continuous	I _C	50	mAdc	
Collector Current - Peak	I _{CM}	100	mA	
Total Device Dissipation (Note 1) @ T _A = 25°C Derate above 25°C	P _D	830 6.6	mW mW/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	150	°C/W
Thermal Resistance, Junction-to-Lead	$R_{ heta JL}$	68	°C/W

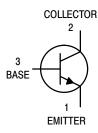
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

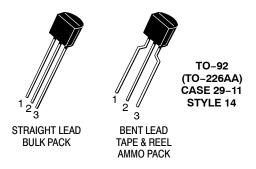
 Mounted on a FR4 board with 200 mm² of 1 oz copper and lead length of 5 mm



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MARKING DIAGRAM



BF422 = Device Code A = Assembly Location

Y = Year WW = Work Week • Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BF422G	TO-92 (Pb-Free)	5000 Units/Box

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BF422

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector – Emitter Breakdown Voltage (Note 1) (I _C = 1.0 mAdc, I _B = 0)	V _(BR) CEO	300	_	Vdc
Collector – Base Breakdown Voltage (I _C = 100 µAdc, I _E = 0)	V _(BR) CBO	300	-	Vdc
Emitter – Base Breakdown Voltage ($I_E = 100 \mu Adc, I_C = 0$)	V _{(BR)EBO}	5.0	-	Vdc
Collector Cutoff Current (V _{CB} = 200 Vdc, I _E = 0)	I _{CBO}	-	0.01	μAdc
Emitter Cutoff Current $(V_{EB} = 5.0 \text{ Vdc}, I_{C} = 0)$	I _{EBO}	-	100	nAdc
ON CHARACTERISTICS				
DC Current Gain (I _C = 25 mAdc, V _{CE} = 20 Vdc)	h _{FE}	50	_	_
Collector – Emitter Saturation Voltage (I _C = 20 mAdc, I _B = 2.0 mAdc)	V _{CE(sat)}	-	0.5	Vdc
Base – Emitter Saturation Voltage (I _C = 20 mAdc, I _B = 2.0 mAdc)	V _{BE(sat)}	-	2.0	Vdc
SMALL-SIGNAL CHARACTERISTICS				
CurrentGain – Bandwidth Product ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 20 \text{ MHz}$)	f _T	60	_	MHz
Common Emitter Feedback Capacitance ($V_{CB} = 30 \text{ Vdc}$, $I_E = 0$, $f = 1.0 \text{ MHz}$)	C _{re}	-	1.6	pF

^{1.} Pulse Test: Pulse Width \leq 300 $\mu s;$ Duty Cycle \leq 2.0%.

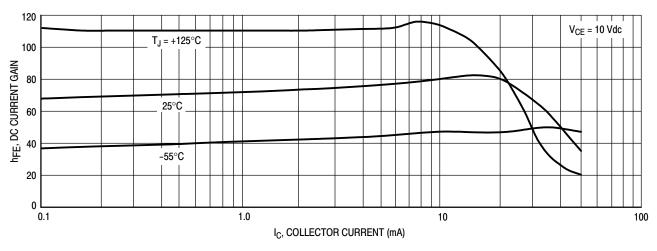


Figure 1. DC Current Gain

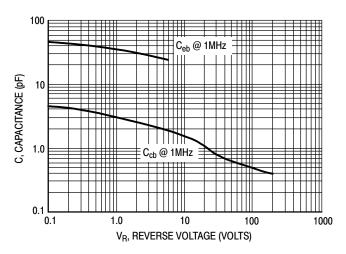


Figure 2. Capacitance

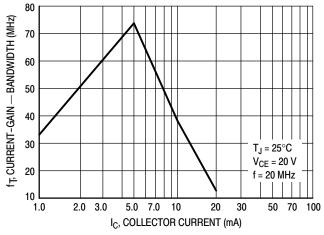


Figure 3. Current-Gain - Bandwidth

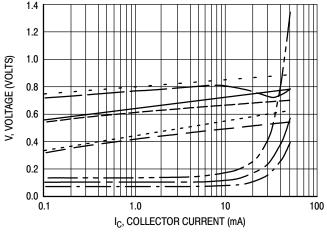
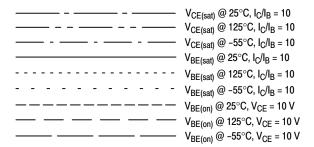
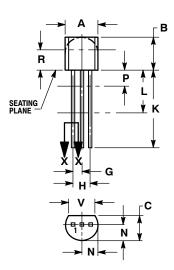


Figure 4. "ON" Voltages

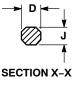


PACKAGE DIMENSIONS

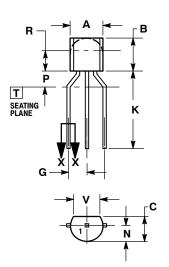
TO-92 (TO-226) CASE 29-11 **ISSUE AM**



STRAIGHT LEAD **BULK PACK**







BENT LEAD TAPE & REEL AMMO PACK



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

STYLE 14:

- PIN 1. EMITTER
 - 2. COLLECTOR BASE

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.45	5.20	
В	4.32	5.33	
c	3.18	4.19	
D	0.40	0.54	
G	2.40	2.80	
7	0.39	0.50	
K	12.70		
N	2.04	2.66	
P	1.50	4.00	
R	2.93		
٧	3.43		

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